



#### SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

#### **Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- High Conductance
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.004 grams (approximate)



Top View

#### Ordering Information (Note 4)

Part Number	Case	Packaging
B0530WS-7-F	SOD323	3000/Tape & Reel
B0530WS-13-F	SOD323	10000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



SE = Product Type Marking Code

## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	21	V
Average Rectified Output Current (See Figure 1)	Io	0.5	Α
Peak Repetitive Forward Current tp = 8.3ms, half sine-wave	I <sub>FRM</sub>	3.5	А
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	IFSM	2	А



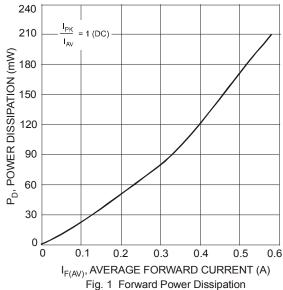
### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	235	mW
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{ hetaJA}$	426	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +125	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 6)	V <sub>(BR)R</sub>	30			>	I <sub>R</sub> = 500μA
Forward Voltage Drop	V <sub>F</sub>	_	0.40	0.36 0.45	٧	I <sub>F</sub> = 0.1A I <sub>F</sub> = 0.5A
Leakage Current (Note 6)	I <sub>R</sub>	_		80 100 500	μΑ	V <sub>R</sub> = 15V V <sub>R</sub> = 20V V <sub>R</sub> = 30V
Total Capacitance	C <sub>T</sub>	_	58		pF	$f = 1MHz, V_R = 0V DC$

Notes: 5. Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. 6. Short duration pulse test used to minimize self-heating effect.



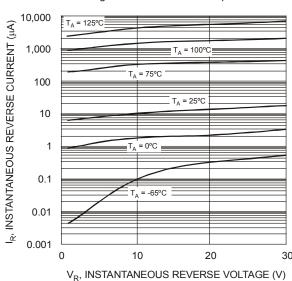
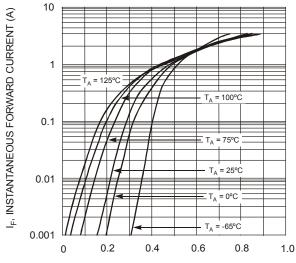
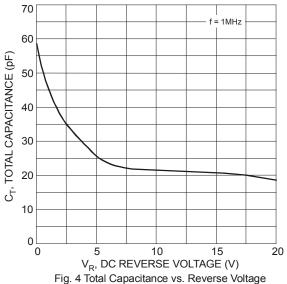


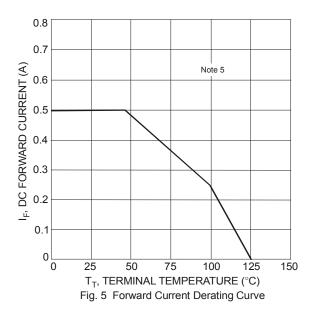
Fig. 3 Typical Reverse Characteristics



 $V_{\rm F}$ , INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 2 Typical Forward Characteristics

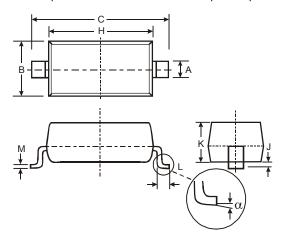






# **Package Outline Dimensions**

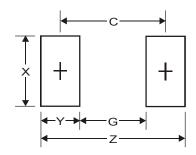
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOD323			
Dim	Min	Max	
Α	0.25	0.35	
В	1.20	1.40	
С	2.30	2.70	
Н	1.60	1.80	
J	0.00	0.10	
K	1.0	1.1	
L	0.20	0.40	
M	0.10	0.15	
α	0°	8°	
All Dimensions in mm			

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
Z	3.75
G	1.05
X	0.65
Υ	1.35
С	2.40



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